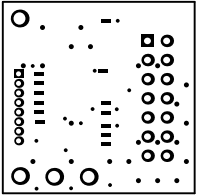
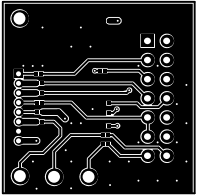


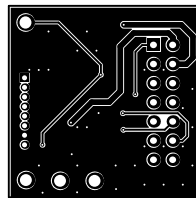
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: XX####	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	Map Overlay Information		
PLOT NAME = Top Overlay	GENERATED : 9/27/2013 1:39:18 PM	TEXAS INSTRUMENTS	



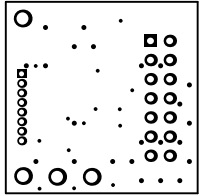
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: XX####	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder Information			
PLOT NAME = Top Solder Mask	GENERATED : 9/27/2013 1:39:18 PM	TEXAS INSTRUMENTS	



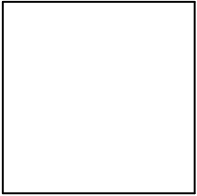
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: XX####	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = M6p Gerber Information			
PLOT NAME = Top Layer	GENERATED : 9/27/2013 1:39:19 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: XX####	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bit6orbegeInformation			
PLOT NAME = Bottom Layer	GENERATED : 9/27/2013 1:39:19 PM		TEXAS INSTRUMENTS

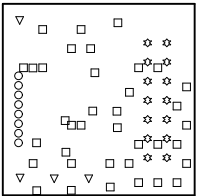


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: XX####	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder Mask Bottom Solder Mask			
PLOT NAME = Bottom Solder Mask	GENERATED : 9/27/2013 1:39:20 PM	TEXAS INSTRUMENTS	



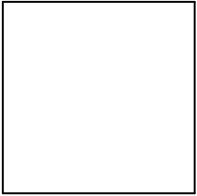
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: XX####	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay Information			
PLOT NAME = Bottom Overlay	GENERATED : 9/27/2013 1:39:20 PM		TEXAS INSTRUMENTS

□



Symbol	Hit Count	Tool Size	Plated	Hole Type
□	38	10mil <0.254mm>	PTH	Round
○	8	26mil <0.66mm>	PTH	Round
✱	14	35mil <0.889mm>	PTH	Round
▽	4	63mil <1.6mm>	PTH	Round
Total		65		

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: XX####	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 9/27/2013 1:39:21 PM	TEXAS INSTRUMENTS	



1000 (mil)

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: XX####	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M21 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 9/27/2013 1:39:21 PM	TEXAS INSTRUMENTS	

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